



#### **DUAL P-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
-30V	$95m\Omega$ @ $V_{GS} = -10V$	-2.7A
-30 V	140mΩ @ V <sub>GS</sub> = -4.5V	-2.2A

## **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP3165SVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

### **Description**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

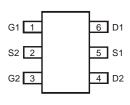
- Backlighting
- DC-DC converters
- Power-management functions

### **Mechanical Data**

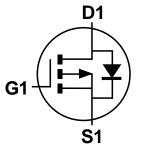
- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)



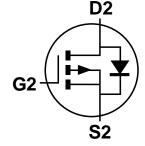
Top View



Top View



Q1 P-Channel MOSFET



Q2 P-Channel MOSFET

#### **Ordering Information** (Note 4)

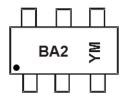
Part Number	Paskage	Packing		
Fait Number	Package	Qty.	Carrier	
DMP3165SVTQ-7	TSOT26	3000	Tape & Reel	
DMP3165SVTQ-13	TSOT26	10000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**



BA2 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: K = 2023) M = Month (ex: 9 = September)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	J	K	L	М	N	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	-30	V		
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	ID	-2.7 -2.2	А		
Maximum Continuous Body Diode Forward Current (Note 5)	Is	-1.3	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			ID	-15	Α

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P <sub>D</sub>	0.88	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	Reja	142	°C/W
Power Dissipation (Note 5)	Po	1.08	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>θJA</sub>	116	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

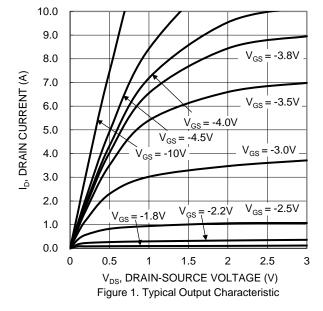
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1.0	μA	V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	-0.5	-1.5	-2.2	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Process	_	65	95	mΩ	V <sub>G</sub> S = -10V, I <sub>D</sub> = -2.7A	
Static Dialii-Source Off-Resistance	RDS(ON)	_	97	140	11122	$V_{GS} = -4.5V, I_D = -2A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	1	287	_			
Output Capacitance	Coss	_	43	_	pF	$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	30	_		1 = 1.000112	
Gate Resistance	Rg	_	8.3	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	3.5	_		V <sub>DS</sub> = -15V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3A	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	6.8	_	nC		
Gate-Source Charge	Qgs	_	0.4	_	nc nc	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -3A	
Gate-Drain Charge	Qgd	_	1.1	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.4	_			
Turn-On Rise Time	t <sub>R</sub>	_	17.9	_	ns	VGS = -10V, VDS = -15V	
Turn-Off Delay Time	tD(OFF)	_	19.6	_	115	$R_g = 6\Omega$ , $R_L = 15\Omega$	
Turn-Off Fall Time	tF	_	21.8	_			

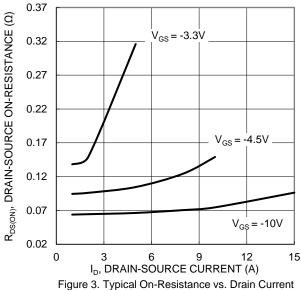
Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.









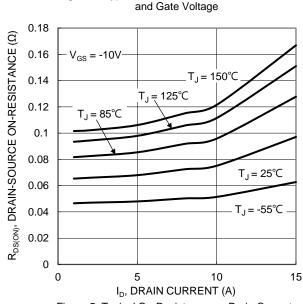
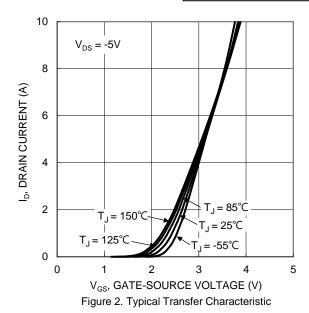
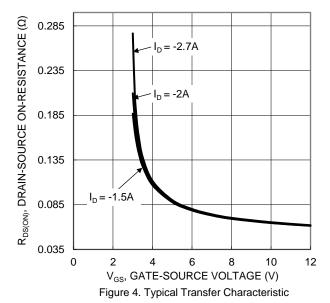


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





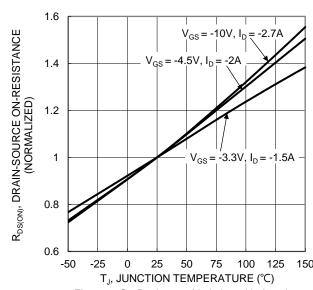
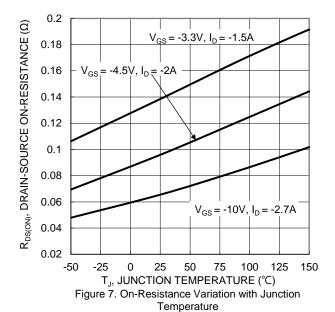
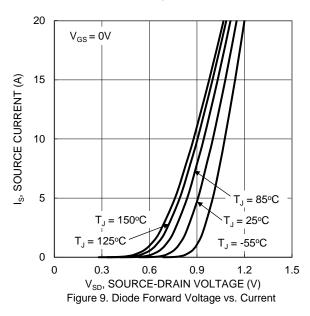


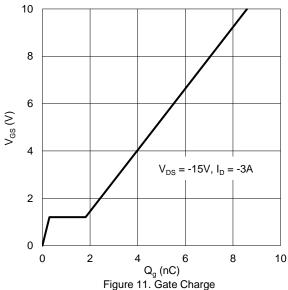
Figure 6. On-Resistance Variation with Junction Temperature











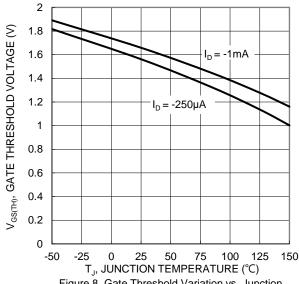
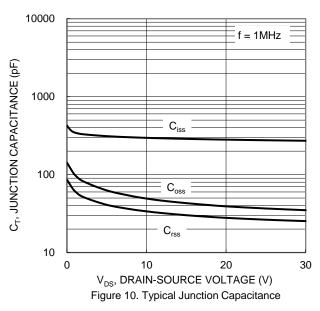
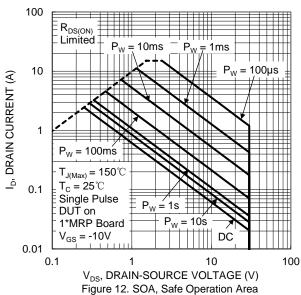


Figure 8. Gate Threshold Variation vs. Junction Temperature







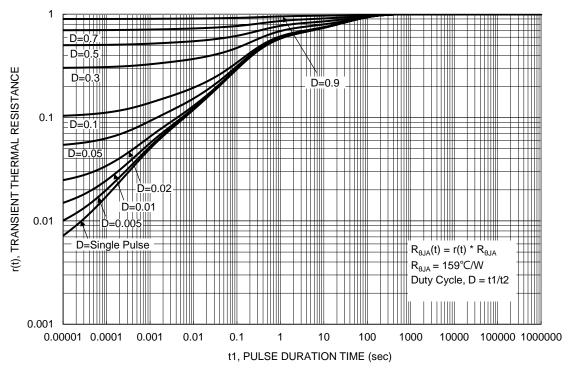


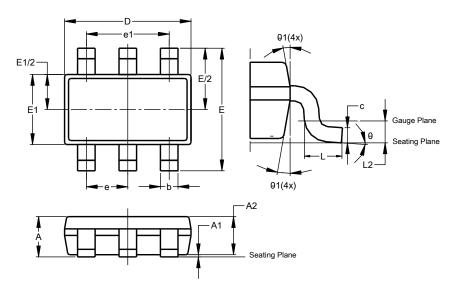
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26

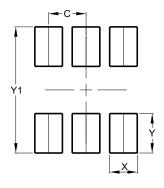


TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	_				
A2	0.840	0.900	_				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300 0.450		-				
С	0.120	0.200	_				
е	0.950 BSC						
e1	1.900 BSC						
L	0.30	0.50	-				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



Dimensions	Value (in mm)			
С	0.950			
Х	0.700			
Y	1.000			
Y1	3.199			



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